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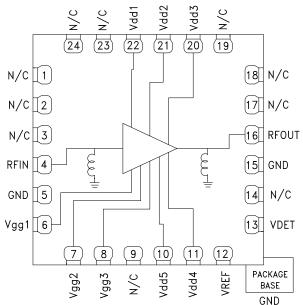


#### **Typical Applications**

The HMC995LP5GE is ideal for:

- Point-to-Point Radios
- Point-to-Multi-Point Radios
- VSAT & SATCOM
- Military & Space

#### **Functional Diagram**



#### Features

Intergrated Power Detector Saturated Output Power: 35.5 dBm @ 24% PAE High Output IP3: 41 dBm High Gain: 27 dB DC Supply: +5V to +7V @ 1200 mA No External Matching Required

#### **General Description**

The HMC995LP5GE is a 4 stage GaAs pHEMT MMIC 2 Watt Power Amplifier with an integrated temperature compensated on-chip power detector which operates between 12 and 16 GHz. The HMC995LP5GE provides 27 dB of gain, 35.5 dBm of saturated output power, and 24% PAE from a +7V supply. The HMC995LP5GE exhibits excellent linearity and is optimized for high capacity digital microwave radio. It is also ideal for 13.75 to 14.5 GHz Ku Band VSAT transmitters as well as SATCOM applications. The HMC995LP5GE amplifier I/Os are internally matched to 50 Ohms and is packaged in a leadless QFN 5x5 mm surface mount package and requires no external matching components.

#### **Electrical Specifications** $T_A = +25^{\circ}$ C, Vdd = Vdd1 = Vdd2 = Vdd3 = Vdd4 = Vdd5 = +7V, Idd = 1200 mA<sup>[1]</sup>

Parameter	Min.	Тур.	Max.	Units
Frequency Range		12 - 16		GHz
Gain <sup>[3]</sup>	24	27		dB
Gain Variation Over Temperature		0.03		dB/ °C
Input Return Loss		9		dB
Output Return Loss		15		dB
Output Power for 1 dB Compression (P1dB)	32	34.5		dBm
Saturated Output Power (Psat)		35.5		dBm
Output Third Order Intercept (IP3) <sup>[2]</sup>		41		dBm
Total Supply Current (Idd)		1200		mA

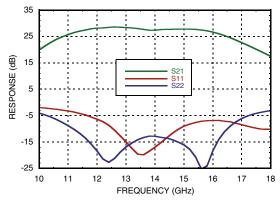
[1] Adjust (Vgg1=Vgg2=Vgg3) between -2 to 0V to achieve Idd = 1200mA typical.

[2] Measurement taken at +7V @ 1200mA, Pout / Tone = +22 dBm

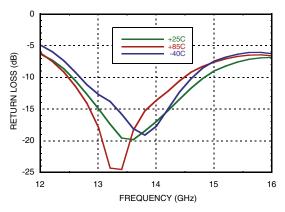
[3] Board loss subtracted out



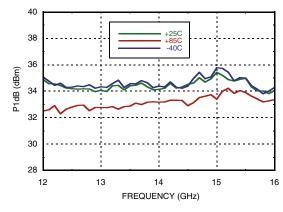
Broadband Gain & Return Loss vs. Frequency



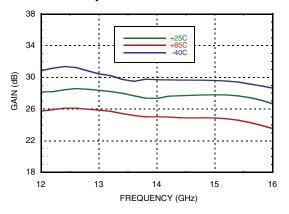
Input Return Loss vs. Temperature



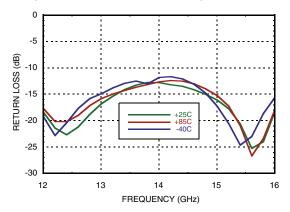
P1dB vs. Temperature



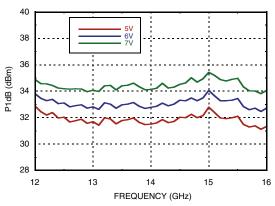
Gain vs. Temperature [1]



#### Output Return Loss vs. Temperature



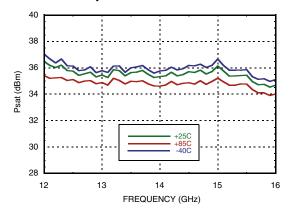
P1dB vs. Supply Voltage



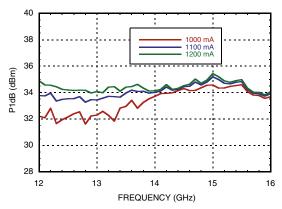




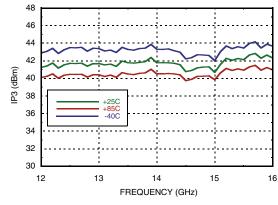
Psat vs. Temperature



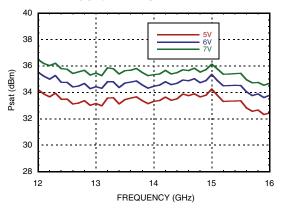
P1dB vs. Supply Current (Idd)



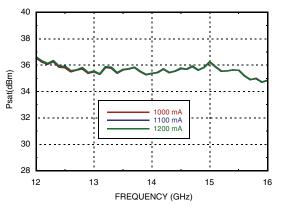
Output IP3 vs. Temperature, Pout/Tone = +22 dBm



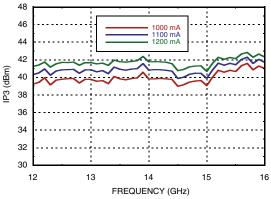
Psat vs. Supply Voltage



Psat vs. Supply Current (Idd)



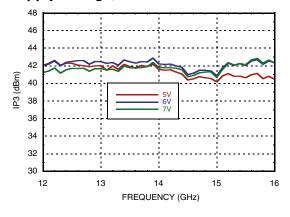




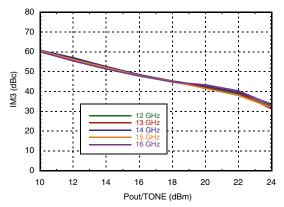


Output IP3 vs.

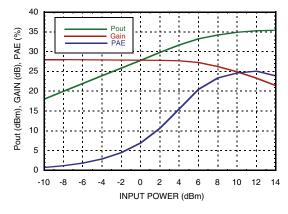
Supply Voltage, Pout/Tone = +22 dBm



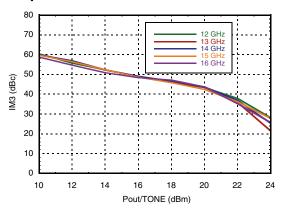
#### Output IM3 @ Vdd = +6V



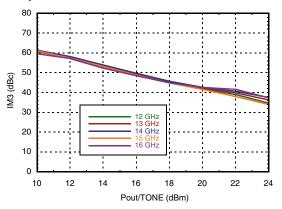
Power Compression @ 13 GHz



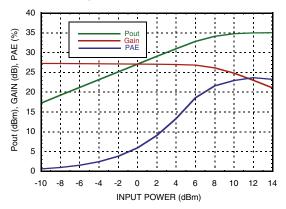
Output IM3 @ Vdd = +5V



#### Output IM3 @ Vdd = +7V



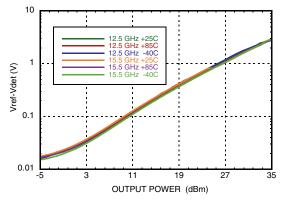
Power Compression @ 15 GHz



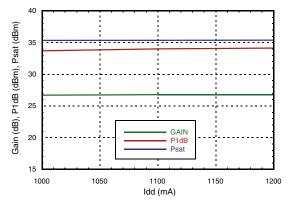




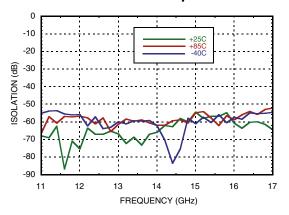
## Detector Voltage vs. Frequency & Temperature



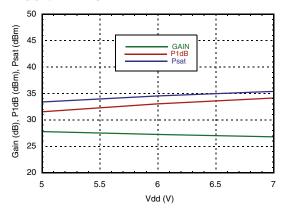
Gain & Power vs. Supply Current @ 14 GHz



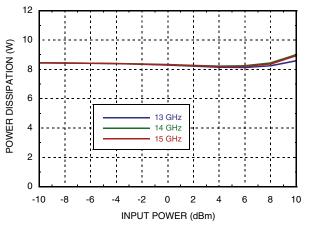
Reverse isolation vs. Temperature



Gain & Power vs. Supply Voltage @ 14 GHz







For price, delivery and to place orders: Hittite Microwave Corporation, 20 Alpha Road, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at www.hittite.com Application Support: Phone: 978-250-3343 or apps@hittite.com





#### Absolute Maximum Ratings

+8V
+24 dBm
150 °C
8.9 W
7.3 °C/W
-65 to +150 °C
-40 to +85 °C
Class 1A

#### Typical Supply Current vs. Vdd

Vdd (V)	ldd (mA)
5	1200
6	1200
7	1200

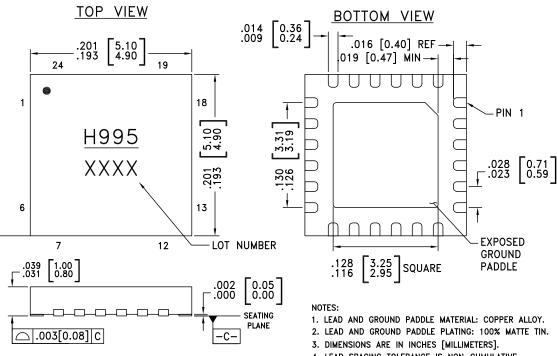
Note: Amplifier will operate over full voltage ranges shown above Vgg adjusted to achieve Idd = 1200 mA







#### **Outline Drawing**



- LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
  PAD BURR LENGTH SHALL BE 0.15mm MAX. PAD BURR HEIGHT SHALL BE 0.25mm MAX.
- 6. PACKAGE WARP SHALL NOT EXCEED 0.05mm
- 7. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.

#### Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking <sup>[1]</sup>
HMC995LP5GE	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL3 <sup>[2]</sup>	<u>H995</u> XXXX

[1] 4-Digit lot number XXXX

[2] Max peak reflow temperature of 260 °C



## HMC995LP5GE



## GaAs pHEMT MMIC 3 WATT POWER AMPLIFIER SMT WITH POWER DETECTOR, 12 - 16 GHz

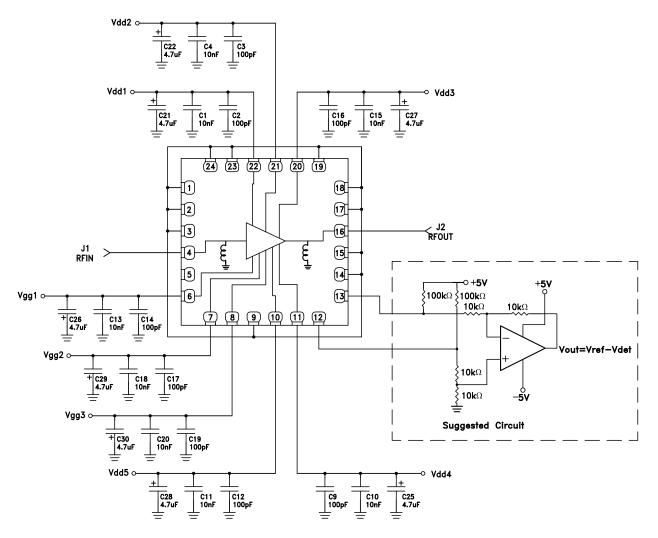
#### **Pin Descriptions**

Pin Number	Function	Description	Interface Schematic
1-3, 9, 14 17-19, 23, 24	N/C	These pins are not connected internally, however all data shown herein was measured with these pins connected to RF/DC ground externally.	
4	RFIN	This pad is DC coupled and matched to 50 Ohms.	RFIN O
5, 15	GND	These pins and package bottom must be connected to RF/DC ground.	
6-8	Vgg1, Vgg2 Vgg3	Gate control for amplifier. External bypass capacitors of 100pF, 10nF and 4.7uF are required. Please follow "MMIC Amplifier Biasing Proceedure" App Note.	↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓
10, 11 20-22	Vdd1, Vdd2, Vdd3, Vdd4, Vdd5	Drain bias voltage for the amplifier. External bypass capacitors of 100pF, 10nF and 4.7μF capacitors are required.	Vdd1−5
12	Vref	DC voltage of diode biased through external resistor, used for temperature compensation of Vdet. See Application Circuit.	OVref
13	Vdet	DC voltage representing RF output power rectified by diode which is biased through an external resistor. See Appilation Circuit.	OVdet
16	RFOUT	This pin is DC coupled and matched to 50 Ohms.	−−−−⊂ RFOUT





#### **Application Circuit**

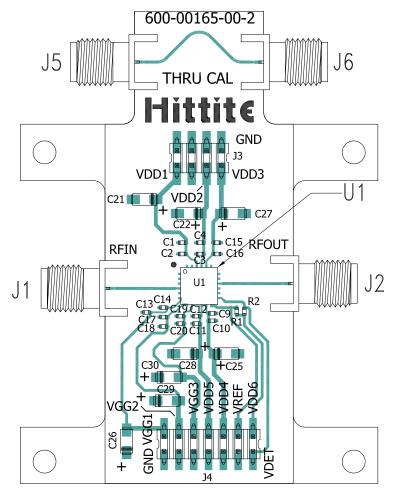




## ROHSV EARTH FRIENDLY

## GaAs pHEMT MMIC 3 WATT POWER AMPLIFIER SMT WITH POWER DETECTOR, 12 - 16 GHz

#### **Evaluation PCB**



### List of Materials for Evaluation PCB EVAL01-HMC995LP5GE [1]

Item	Description	
J1, J2, J5, J6	K Connector SRI	
J3, J4	DC Pin	
C2, C3, C9, C12, C14, C16, C17, C19	100 pF Capacitor, 0402 Pkg.	
C1, C4, C10, C11, C13, C15, C18, C20	10 nF Capacitor, 0402 Pkg.	
C21, C22, C25 - C30	4.7uF Capacitor, Case A.	
U1	HMC995LP5GE Power Amplifier	
РСВ	600-00163-00 Evaluation PCB	

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350 or Arlon FR4

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.